

### IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Sunfei Fang

Art Unit:

2823

Serial No.: 09/941,963

Examiner: Hsien Ming Lee

Filed:

August 28, 2001

Docket:

01-P-14755 US

For:

Method of Cleaning an Inter-Level Dielectric Interconnect

#### **DECLARATION FILED UNDER 37 C.F.R. § 1.131**

I, Brian A. Carlson, do hereby state that:

- 1. I am a patent attorney (Reg. No. 37,793) with the firm of Slater & Matsil, L.L.P., and I co-wrote the above-referenced patent application.
- 2. Slater & Matsil, L.L.P. received an invention disclosure for the above-identified patent application from Infineon Technologies North America on April 25, 2001, which is prior to May 15, 2001, the filing date of the cited U.S. Patent Application No. 2001/0049150A1 to Nakagawa et al. A copy of the docket system report and the disclosure form is provided as Exhibit A.
- 3. The inventor provided me with an email showing that on May 10, 2001, the inventor sent an email to two co-workers illustrating the results of an initial etch rate study related to the inventive concept of the above-referenced patent application. A copy of the email is provided as Exhibit B.
- 4. Between May 16, 2001 and August 28, 2001, with the assistance of a technical writer, Mea Butler, I prepared the specification of the above-referenced patent application. A copy of the firm invoice detailing the specific dates and activities is provided as Exhibit C.

5. On August 28, 2001, my firm filed the patent application with the United States Patent and Trademark Office. A copy of the return postcard stamped by the United States Patent and Trademark Office is provided as Exhibit D.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1000 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Respectfully submitted,

///22/02 Date

Brian A. Carlson Reg. No. 37,793

Slater & Matsil, L.L.P. 17950 Preston Rd., Suite 1000 Dallas, Texas 75252

Tel: (972) 732-1001 Fax: (972) 732-9218



### **EXHIBIT A**

RECEIVED
DEC-4 2002

DEC -4 2002 TECHNOLOGY CENTER 2800

Acr.

# Case Tracking System U.S. Patent Case Detail Report

Date: April 25, 2001

Case Number: INF-01-E-02249

Status: New

Application Type: Utility

Filing Date:

App. Serial No.:

Title: A Method of Liner Pre-Clean to Enable Formation of Reliable Contacts in Organic ILD

Case Management:

Sr. Attorney: None

Case Administrator: None

Client:

**INF** 

Infineon Technologies North America Corp.

**Primary Contact:** 

Stanton Braden

186 Wood Avenue South

Iselin, NJ 08830

Previous Cases: None

No Foreign Filing 'Reminder Date Due' present and no 'Date Foreign Filed' present

**Inventor Ids:** 

FANG NING .

Abstract:

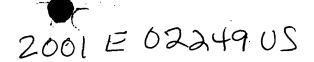
None

Notes:

None

No Office Actions

No Assignments





#### Invention Disclosure

Created By: Sunfei Fang Created On:

Last Modified By: Thomas Schiml Last Modified On:

Required fields are marked with the asterlsk (\*) and must be filled in to complete the form .

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Sequence Number	
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Infineon	IBM
Docket#	IBM # Docket #  Attacney  Pocket#  Sent wintgront Date
Attorney	Attorney
	Docket#
	Sent to intracon Date

Supervising Party =

Inventors

\* THIS PAGE IS FOR INVENTOR INFO ONLYX

inventor #1	
* Notes ID	Sunfei Fang/Fishkill/Contr/IBM
* Full Name	Sunfei Fang
Serial #(if applicable)	
* Social Security #	
* Company	○ IBM • Infineon ○ UMC ○ Other
* Department	T9XA
→ Project	
·	
Internal Address	
■ Bldg\Zip	630/33i
*Telephone	845-892-9863
Home Address	
Street	46 Ehmer Drive
City	LaGrangeville
State	NY
Zip	12540
Home PHONE CITIZENSHIP	845 223 - 1727
CITIZENSHIP	CHINA



### Inv ntion Disclosur

Created By: Sunfei Fang Created On: Last Modified By: Sunfei Fang Last Modified On;

Required fields are marked with the asterisk (\*) and must be filled in to complete the form .

Status	
Sidjus 2Submitted	

Plan Information

Attorney  Attorney  Docket #  Docket #  Docket #  Sent Reuntineon Date

### SUPPLIED THE PROPERTY.

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Witnessed and understood by:		Witnessed and understood by	<i>y</i> :
Jay Ning		Jiang (as	
Signature of Witness	Date	Signature of Witness	Date/
Jay Ming			
Print Name of Witness		Print Name of Witness	·
		Tiang Yan	· ·
Telephone Number 845)894	-9536	Telephone Number 2-0	7546
Company Name/Location		Company Name/Location	
Infineon/EFK		Infine on	/Fish fill

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A Method of Liner Pre-Clean to Enable Formation of Reliable C ntacts in Organic ILD

#### Leroplem Solved by this invention (Summary)....

Current liner pre-clean with Ar plasma results re-deposition of organic contaminant on contact surface. It could degrade adhesion of liner material to underlying conductor, cause contact reliability problems such as via resistance shift. This work discloses a method of liner pre-clean that will achieve organic contaminant-free clean surface, it would improve adhesion of liner material to underlying conductor and ensure formation of reliable contacts in organic ILD.

List all Wutters Descriptions of lovention

(eg: Described in Engineering Natebook No..... Pgs.

Cleanroom Notebook

Critical Dates (minidally or minidally yv)

\*Date(s) Invention Conceived:

\*Date(s) Invention Explained to Witness(es):

Date(s) Embodiment(s) of the Invention Constructed:

Date(s) Embodiment(s) of Invention Tested:

Planged Use in Products, tise Durside Company, Danionstration Disclosure, or Publication of the Inventions (Give Dates)

Description of Invention (Text Graphics, etc.)

**A** 

reliable contacts vs Liner Precieen.PDF

IMPORTANT: Information provided by this form may be used to prepare a patent application which will be signed by the inventor(s). Inventors should take great care in accurately completing this form in providing full information concerning prior art. False statements or concealment in obtaining a patent will subject applicant to fine and/or imprisonment (18 USC 1001) and may jeopardize the validity of the patent.

#### Evaluation: Aspects

\*What exactly is your claim? Give precisely the difference between your invention (method, structure) and the closest previous work you know of.

A Method of Liner Pre-Clean using N2 containing plasma to achieve organic contaminant-free surface. It could improve adhesion of liner material and underlying conductor, and enables formation of reliable contacts.

\*What existing solutions are known? Please cite references, patents, etcl None.

\*What are the TECHNICAL pros and cons over existing solutions?

Pro: Achieve organic contaminant-free clean surface to ensure formation of reliable contacts.

\*Have you searched for prior art? How was this search performed? Searched for Prior ART. Did not find any.

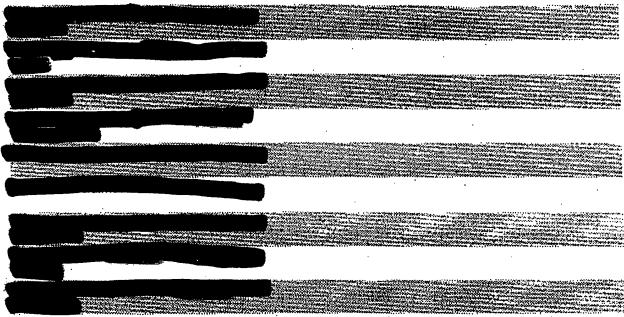
Please comment on the following:

This Disclosure:

Comment







Do you have any other comments regarding this disclosure?

1-7	~ <b>I</b>	· ·		
Inventor #1's Signature	Date	, ,	Inventor #2's Signaturo	Deta
Inventor #2's Signature	Date		Inventor #4's Signature	Dāta
Inventor 55's Signature	Date	·		

		,		
Witness #1's Signature	Onto	Witness #2's Signature	Date	



### **EXHIBIT B**

#### **Brian Carlson**

From:

Sunfei Fang

Sent:

Wednesday

To: Subject:

Sputter pre-clean



Ar N2 sputter clean.doc

Brian,

My college found out original mails and forwarded back to me. Please find I forward them here.

Please let me know if you have any other suggestions.

Best Regards, Sunfei

---- Forwarded by Sunfei Fang/Fishkill/Contr/IBM on

Keith Wong

To: Sunfei Fang/Fishkill/Contr/IBM@IBMUS

CC:

From: Keith Wong/Fishkill/IBM@IBMUS

Subject: Sputter pre-clean

---- Forwarded by Keith Wong/Fishkill/IBM on

Sunfei Fang

Terry Spooner/Fishkill/IBM@IBMUS

05/10/2001 09:44 ) cc: AM From:

Keith Wong/Fishkill/IBM@IBMUS
Sunfei Fang/Fishkill/Contr/IBM@IBMUS

Subject: Sputter pre-clean

Terry,

Keith has done initial etch rate study with N2 addition during liner sputter pre-clean. Here is the data that you wanted: (See attached file: Ar N2 sputter clean.doc)

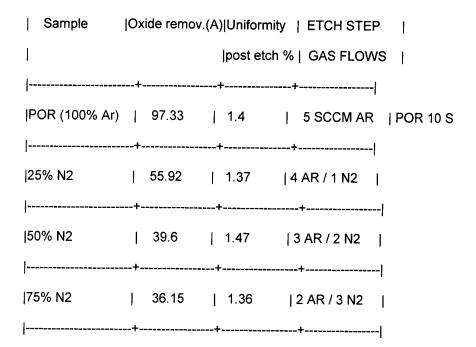
I'd like to talk to you (tomorrow?) to see how to proceed from here. Our proposal is:

- (i) a few short loop wafers for cross-section SEM to see if any improvement of corner-erosion;
- (ii) Electrical split to see if any improvement for via reliability

Best Regards,

### Sunfei

'ps could you let me know when would be a good time to discuss it?





## **EXHIBIT C**

### Slater & Matsil, L.L.P.



Suite 1000 17950 Preston Road Dallas, Texas 75252

Phone: 972-732-1001 Fax: 972-732-9218

### BILL TO

Mr. Stanton C. Braden
Infineon Technologies North America
c/o Siemens Corp. Legal and IP Dept.
186 Wood Avenue South
Iselin, NJ 08830

### Invoice

PROJECT
01 P 14755 (01 E 2249)

DATE	INVOICE#
8/29/2001	1356

DATE	ATTORNEY	HRS	DESCRIPTION
			PROFESSIONAL FEES
5/16/2001	Butler	0.5	Prepare communication with inventor(s).
5/17/2001		3.5	Review file and background technology.
5/21/2001	Butler	3.5	Interview Inventor and prepare claims.
5/22/2001	Butler	8.1	Prepare patent application.
5/24/2001	Butler	4.8	Prepare patent application.
5/30/2001	Butler	4.1	Prepare patent application.
6/7/2001	Carlson	2	Review application.
6/8/2001	Butler	2	Prepare patent application.
6/12/2001	Butler	8	Revise Draft
6/20/2001	Butler	2.5	Revise application.
7/9/2001	Carlson	6	Work on application.
7/23/2001	Carlson	6.5	Work on application.
7/24/2001	Carlson	6.8	Work on application.
7/31/2001	Carlson	0.5	Teleconference with inventor re: modifications to application.
8/1/2001	Carlson	1.5	Incorporate inventor updates into application.
8/7/2001	Carlson	1	Incorporate inventor updates into application.
8/9/2001	Carlson	0.5	Teleconference with inventor re: updates to application.
8/10/2001	Carlson	0.9	Incorporate inventor updates into application.
8/15/2001	Carlson	0.3	Teleconference with inventor re: formal papers.
8/27/2001	Carlson	0.3	Review formal drawings.
8/28/2001	Carlson	0.5	Review formal papers; file application.
			OTHER CHARGES
			Filing fee for 01-P-14755

Total

### **EXHIBIT** D

The stamp of the USPTO, placed hereon, acknowledges receipt of:

Applicant: Fang

Attorney Docket: 01P14755 US

Serial No: TBD

Art Unit: TBD

Date Filed: August 28, 2001

Date Mailed: August 28, 2001

TITLE: Method of Cleaning an Inter-Level Dielectric Interconnect

- Utility Patent Application Transmittal (1 page)

- Complete Copy of Patent Application (21 pages), to include:
  - Specification (19 pages)
  - Formal Drawings (2 pages)
- Declaration and Power of Attorney (3 pages)
- Assignment Recordation Cover Sheet (1 page)
- Copy of Original Signed Assignment (2 pages)
- Information Disclosure Statement (2 pages) and 1 reference
- Fee Transmittal (1 original and 1 copy)
- Check in the amount of \$804.00
- Two (2) Return Postcards

Received by. Slater & Matsil L.L.

1c971 U.S. PTO